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To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Byung-lyul PARK, Ju-hyuk CHUNG, Ja-hyung HAN

Additional name(s) of conveying party(ies) attached? No

Name: Samsung Electronics Co., Ltd.

2. Name and address of receiving party(ies):

Internal Address:

Street Address: 416 Maetan-dong, Paldal-gu,

City: Suwon-city, Kyungki-do, REPUBLIC OF KOREA

Additional name(s) & address(es) attached? No

3. Nature of conveyance:

Assignment

Merger

Security Agreement

Change of Name

Other

Execution Date: July 7, 2002

4. Application number(s) or patent number(s):

ution date of the application is: July 7, 2002 If this document is being filed together with a new app

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Eugene M. Lee

Internal Address: LEE & STERBA, P.C.

Street Address: 1101 Wilson Boulevard, Suite 2000

City: Arlington, State: VA ZIP: 22209

6. Total number of applications and patents involved: One

7. Total fee (37 C.F.R., 3.41).....\$40.00

Enclosed

X Authorized to be charged to deposit account

8. Deposit account number: 5-01645

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July 17, 2002

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**PATENT** REEL: 013114 FRAME: 0197 249/295

U.S. Rights-Sole or Joint

## ASSIGNMENT

name and address of assignee	For good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, each undersigned inventor has sold and assigned, and by these presents hereby sells and assigns, unto SAMSUNG ELECTRONICS CO., LTD.  416 Maetan-dong, Paldal-gu, Suwon-city, Kyungki-do, Republic of Korea	
	(hereinafter ASSIGNEE) all right, title and interest for the United States, its territories and possessions in and to his invention relating to	
title of invention	METHOD FOR MANUFACTURING A SEMICONDUCTOR DEVICE HAVING A METAL-INSULATOR-METAL CAPACITOR AND A DAMASCENE WIRING LAYER STRUCTURE	
check one	as set forth in this United States Patent Application  X executed concurrently herewith	
WHOLK OHE	cxccuted on  Serial No Filed	

in and to said United States Patent Application including any and all divisions or continuations thereof and in and to any and all Letters Patent of the United States which may issue on any such application or for said invention, including any and all reissues or extensions thereof, to be held and enjoyed by said ASSIGNEE, its successors, legal representatives and assigns to the full end of the term or terms for which any and all such Letters Patent may be granted as fully and entirely as would have been held and enjoyed by the undersigned had this Assignment not been made;

Each of the undersigned hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all such Letters Patent to said ASSIGNEE, its successors or assigns in accordance herewith;

Each of the undersigned warrants and covenants that he has the full and unencumbered right to sell and assign the interests herein sold and assigned and that he has not executed and will not execute any document or instrument in conflict herewith;

Each of the undersigned further covenants and agrees he will communicate to said ASSIGNEE, its successors, legal representatives or assigns all information known to him relating to said invention or patent application and that he will execute and deliver any papers, make all rightful oaths, testify in any legal proceedings and perform all other lawful acts deemed necessary or desirable by said ASSIGNEE, its successors, legal representatives or assigns to perfect title to said invention, to said application including divisions and continuations thereof and to any and all Letters Patent which may be granted therefor or thereon, including reissues or extensions, in said ASSIGNEE, its successors, or assigns or to assist said ASSIGNEE, its successors, legal representatives or assigns in obtaining, reissuing or enforcing Letters Patent of the United States for said invention;

Each of the undersigned hereby grants the firm of LEE & STERBA, P.C. the power to insert in this Assignment any further identification which may be necessary or desirable to comply with the rules of the U.S. Patent and Trademark Office for recordation of this Assignment.

NAMES AND SIGNATURES OF INVENTORS			
Name: Byung-lyul PARK	Signature: Byung-Lyul Park	Date: 01/07/2002	
Name: Ju-hyuk CHUNG	Signature: Ju - Hyuk CHUNG	Date: Oh/oh/2001	
Name: Ja-hyung HAN	Signature: Ja - hours HAN	Date: 27/07/200	
NAMES AND SIGNATURES OF WITNESSES			
Name:	Signature:	Date:	
Name:	Signature:	Date:	

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